

# NL-putty10-s

## Non-Silicone Lightweight Thermal Conductive Putty

LiPOLY's NL-putty10-s is a non-silicone, low-density gap filling material without volatile low-molecular-weight siloxane volatile, low total volatile gas. It is suitable for electronic products and automotive electronic devices. Its low density and lightweight characteristics improve product performance, reduce production costs, and minimize material usage and energy consumption. With a thermal conductivity of 10.0 W/m\*K and high deformability, it can flexibly adapt to gap and has tolerance compensation properties. It can overcome overflow and drying problems, improve heat conduction, and is suitable for automated dispensing production.

### ■ FEATURES

- / Lightweight, Low Density, Thermal Conductivity: 10.0 W/m\*K
- / High flow rate, extrusion rate under 90psi&60s conditions: 20g/min
- / Bond line thickness:100~1500μm
- / Non-silicone resin materials
- / Designed to remove manufacturing tolerances
- / Does not produce stress on delicate components
- / No vertical flow
- / Dispensable for serial manufacture
- / For any high compression and low stress application

### ■ TYPICAL APPLICATION

/ lightweight applications, such as Automotive electronic devices, Mobile communication device, Drone & aircraft, Sports and leisure electronic products, Portable computers and tablets, wearable devices, Portable game consoles, VR devices and etc.

### ■ CONFIGURATIONS

- / Cartridges: 30ml, 150ml
- / Bucket: 1kg, 25kg

### ■ PRESERVATION

It can be preserved for 60 months under the condition of unopened and under room temperature 25°C.

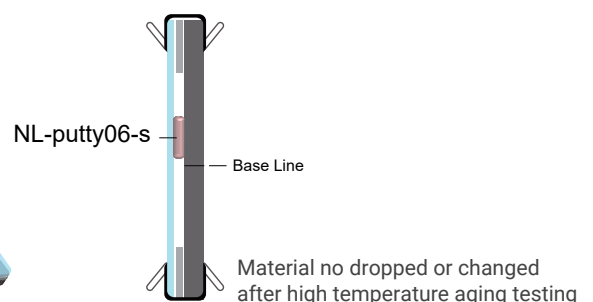


### ■ TYPICAL PROPERTIES

PROPERTY	NL-putty10-s	TEST METHOD	UNIT
Color	Red	Visual	-
Resin base	Non-Silicone	-	-
Viscosity	10000	DIN 53018	Pa.s
Flow Rate (30cc EFD tube, 2.35mm Orifice diameter, 90psi&60s)	20	By LiPOLY	g/min
Density	2.6	ASTM D792	g/cm <sup>3</sup>
Application temperature	-60~125	-	°C
Bond line thickness	100~1500	-	μm
Shelf life	60 months	-	-
ROHS & REACH	Compliant	-	-
<b>ELECTRICAL</b>			
Dielectric breakdown	10	ASTM D149	KV/mm
Volume resistivity	>10 <sup>12</sup>	ASTM D257	Ohm-m
<b>THERMAL</b>			
Thermal conductivity	10.0	ASTM D5470	W/m*K
Thermal impedance@10psi / 80°C	0.043	ASTM D5470	°C-in <sup>2</sup> / W
Thermal impedance@30psi / 80°C	0.039	ASTM D5470	°C-in <sup>2</sup> / W
Thermal impedance@50psi / 80°C	0.036	ASTM D5470	°C-in <sup>2</sup> / W

### ■ VERTICAL RELIABILITY

Using 1.5mm pad as a gap control, put the putty between the aluminum and the glass panel mark the initial position. Then, place it in the oven with 125°C for 1,000 hours and observe its displacement after reliability test



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